Declaration for U.S. Patent Application

| As a below named inventor, | I hereby declare the | nat: |
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| Thereby claim foreign priority benefits under Title 35, United States Code, § 119 (a) - (d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application for which priority is claimed: | My residence, pos | st office address and citizer | nship are as st | ated below | next to my name. | | | |
|--|---------------------------|-------------------------------|------------------|---------------|----------------------------|---|--|--|
| was filed onas United States Application Number or PCT International Application Number and was amended on(if applicable). I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended by any amendment referred to above. I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, \$ 1.56. Thereby claim foreign priority benefits under Title 35, United States Code, \$ 119 (a) - (d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a ding date before that of the application for which priority is claimed: Priority Claimed [List prior | names are listed b | elow) of the subject matter | which is clai | med and fo | or which a patent is soug | | | |
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| Foreign (Number) (Country) (Day/Month/Year Filed) See note A on (Number) (Country) (Day/Month/Year Filed) Back of this Yes No Page) (Number) (Country) (Day/Month/Year Filed) Yes No (Number) (See note B on back of this page) See attached list for additional prior foreign applications I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application. (List Prior U.S. Applications) (Appln. Serial No.) (Filing Date) (Status: Patented, Pending, Abandoned) | Hist prior | 2000-270963 | Iapan | 07 | 7/09/2000 | · · · · · · · · · · · · · · · · · · · | | |
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| | | (Appln. Serial No.) | (Filing | Date) | (Status: Patented, Pend | ding, Abandoned) | | |

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:



Please direct all communications to the following address:



PATENT TRADEMARK OFFICE

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

| (See note C above) | Full name of sole or first inventor (given name, family name) Takashi MORIUCHI | | | | | | |
|--|--|--|--|--|--|--|--|
| , | Inventor's signature <u>Takashi Movinchi</u> Date 31/07/2001 | | | | | | |
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| Fall name of second | inventor (given name, family name) | | | | | | |
| Inventor's signature | Date | | | | | | |
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| Full name of third in | ventor (given name, family name) | | | | | | |
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